

3.8V-36V Vin, 5A, High Efficiency Synchronous Step-down DCDC Converter with Programmable Frequency

FEATURES

- Wide Input Range: 3.8V-36V
- Up to 5A Continuous Output Current
- Integrated 45mΩ High-Side and 20mΩ Low-Side Power MOSFETs
- Feedback Reference Voltage: 0.8V ±1%
- Adjustable Frequency 100KHz to 1.1MHz
- Precision Enable Threshold for Programmable Input Voltage Under-voltage Lock Out Protection (UVLO) Threshold and Hysteresis
- Minimum On-time: 100ns
- Internal Soft-start Time: 4ms
- Over-voltage and Over-Temperature Protection
- Pulse Skipping Mode (PSM) with 25uA Quiescent Current in Sleep Mode
- External Clock Synchronization

- Low Dropout Mode Operation
- Derivable Inverting Voltage Regulator
- Frequency Spread Spectrum (FSS) Modulation for EMI Reduction
- Available in an ESOP-8 Package

APPLICATIONS

- Battery Pack Powered System Cordless Power Tools, Cordless Home Appliance, Drone, Aero Modeling, GPS Tracker etc.
- Cigarette Lighter Adapters, Chargers
- LCD Display
- USB Type-C Power Delivery, USB Charging
- Industrial and Medical Distributed Power Supplies
- Optical Communication and Networking System
- Automotive System

DESCRIPTION

The TPS54540D is 5A synchronous buck converters with wide input voltage, ranging from 3.8V to 36V, which integrates a $45m\Omega$ high-side MOSFET and a $20m\Omega$ low-side MOSFET. The TPS54540D , adopting the peak current mode control, supports the Pulse Skipping Modulation (PSM) with typical 25uA low quiescent current which assists the converter on achieving high efficiency at light load or standby condition.

The TPS54540D features programmable switching frequency from 100 kHz to 1.1 MHz with an external resistor, which provides the flexibility to optimize either efficiency or external component size. The converter supports external clock synchronization with a frequency band from 100kHz to 1.1MHz. The TPS54540D allows power conversion from high input voltage to low output voltage with a minimum 100ns on-time of highside MOSFET, and support Low Dropout Mode Operation(LDO).

The TPS54540D is an Electromagnetic Interference (EMI) friendly buck converter with internal integration Frequency Spread Spectrum(FSS) for EMI reduction.

The TPS54540D offers cycle-by-cycle current limit and hiccup over current protection, thermal shutdown protection, output over-voltage protection and input voltage under-voltage protection. The device is available in an 8-pin thermally enhanced ESOP-8 package.



FUNCTIONAL BLOCK DIAGRAM

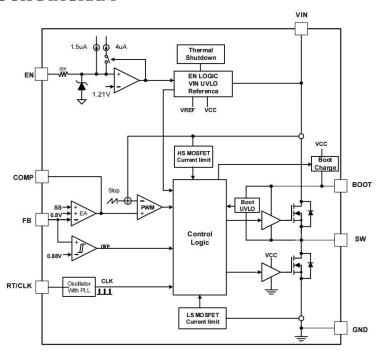


Figure 1. Functional Block Diagram

ELECTRICAL CHARACTERISTICS

 V_{IN} =24V, T_J =-40 ~ +125°C, typical value is tested under 25°C

SYMBOL	PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNIT
V _{IN}	Operating input voltage		3.8		36	V
17	Input UVLO Threshold	V _{IN} rising		3.5	3.7	V
V _{IN_UVLO}	Hysteresis			400		mV
I_{SD}	Shutdown current from V _{IN} pin	EN=0V, no load		1	3	μΑ
I_Q	Quiescent current from V _{IN} pin	ENfloating, no load, V_{BST} - V_{SW} =5 V		25		μΑ
R _{DSON_H}	High-side MOSFET on-resistance	V_{BST} - V_{SW} = $5V$		45		mΩ
R _{DSON_L}	Low-side MOSFET on-resistance			20		mΩ
V_{REF}	Reference voltage of FB		0.792	0.80	0.808	V
GEA	Error amplifier trans-conductance	$2\mu A {<} I_{COMP} {<} 2\mu A, V_{COMP} {=} 1V$		300		uS
I _{COMP_SRC}	EA maximum source current	$V_{FB}\!\!=\!\!V_{REF}\!\!-\!\!100mV, V_{COMP}\!\!=\!\!1V$		30		μA
I _{COMP_SNK}	EA maximum sink current	$V_{FB}\!\!=\!\!V_{REF}\!\!+\!\!100mV,V_{COMP}\!\!=\!\!1V$		30		μA
V _{COMP_H}	COMP high clamp			3		V
V _{COMP_L}	COMP low clamp			0.4		V
I _{LIM_HS}	High-side power MOSFET peak current limit threshold		6.8	8	9.2	A
I _{LIM_LSSRC}	Low-side power MOSFET souring current limit threshold			9		A
t _{HIC_W}	Over current protection hiccup wait time			512		cycles



$t_{\mathrm{HIC_R}}$	Over current protection hiccup restart time			8192		cycles
$V_{\rm EN_H}$	Enable high threshold			1.18	1.25	V
V _{EN_L}	Enable low threshold		1.03	1.1		V
I _{EN_L}	Enable pin pull-up current	EN=1V	1	1.5	2	μΑ
I _{EN_H}	Enable pin pull-up current	EN=1.5V		5.5		μΑ
t _{ss}	Internal soft start time			4		ms
F _{RANGE_RT}	Frequency range using RT mode		100		1100	KHz
F_{SW}	Switching frequency	$R_{RT}=200 \text{ k}\Omega(1\%)$	400	450	500	KHz
Frange_clk	Frequency range using CLK mode		100		1100	KHz
F_{JITTER}	Frequency spread spectrum in percentage of Fsw			±6		%
t _{ON_MIN}	Minimum on-time	V _{IN} =24V		100		ns
17	Feedback overvoltage with respect	V _{FB} /V _{REF} rising		110		%
$ m V_{OVP}$	to reference voltage	VfB/Vref falling		105		%
V _{BOOTUV}	BOOT-SW UVLO threshold	V _{BST} -V _{SW} rising		2.36		V
	Hysteresis	V _{BST} -V _{SW} falling		300		mV
т	Thermal shutdown threshold	T _J rising		170		°C
T_{SD}	Hysteresis			25		°C

ABSOLUTE MAXIMUM RATINGS

DESCRIPTION	VALUE	UNIT
V_{IN} , V_{EN}	38	V
$ m V_{BOOT}$	44	V
$ m V_{SW}$	38	V
$ m V_{FB}, m V_{COMP}, m V_{RT/CLK}$	6	V
$ m V_{BOOT} ext{-}V_{SW}$	6	V
Operating junction temperature T _J	-40 ~ +150	°C
Storage temperature T _S	- 65 ∼ +150	°C

RECOMMENDED OPERATING CONDITIONS

DESCRIPTION	VALUE	UNIT
Input voltage range $V_{\rm IN}$	3.8~36	V
Output voltage range VOUT	0.8~35	V
Operating junction temperature T _J	-40 ~ +125	°C

ESD RATINGS

DESCRIPTION	VALUE	UNIT	
Human Body Model(HBM), ANSI-JEDEC-JS-001-2014	-2~+2	KV	
Charged Device Model(CDM), ANSI-JEDEC-JS-002-2014	-0.5~+0.5	KV	



TYPICAL CHARACTERISTICS

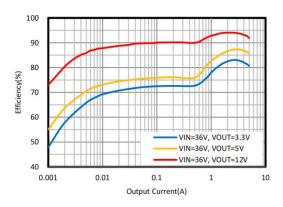


Figure 2. Efficiency vs Load Current, Vin=36V

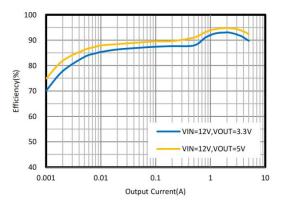


Figure 4. Efficiency vs Load Current, Vin=12V

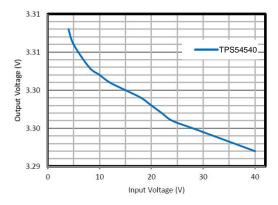


Figure 6. Line Regulation V_{OUT} =3.3V, I_{LOAD} =5A

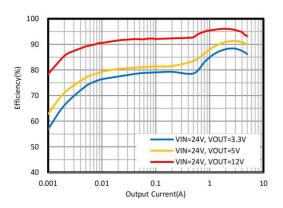


Figure 3. Efficiency vs Load Current, Vin=24V

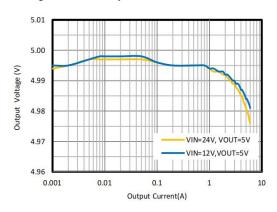


Figure 5. Load Regulation (Vout=5V)

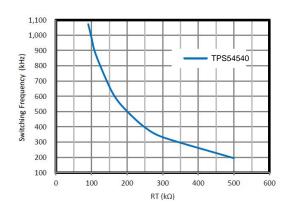
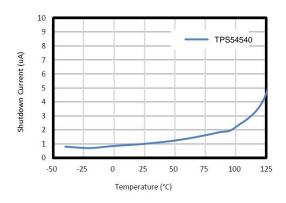


Figure 7.Clock Frequency vs RT/CLK Resistor





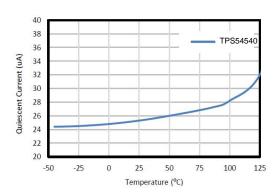


Figure 8. Shutdown Current vs Temperature

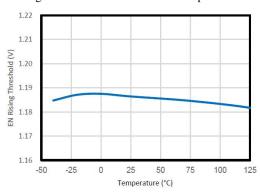


Figure 9. Quiescent Current vs Temperature

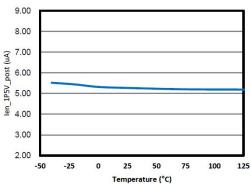


Figure 10. EN Threshold vs Temperature

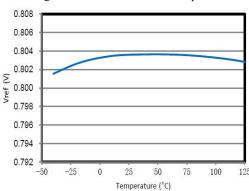


Figure 11. EN Pull-up Current vs Temperature

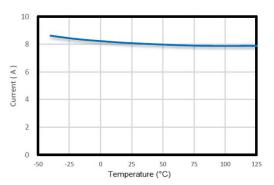


Figure 12. Reference Voltage vs Temperature

Figure 13. Peak Current Limit vs Temperature

PIN CONFIGURATION

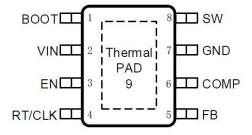


Figure 14. 8-Lead Plastic E-SOP



NO.	NAME	PIN FUNCTION	
		Power supply bias for high-side power MOSFET gate driver. Connect a 0.1uF capacitor from BOOT	
1 BOOT		pin to SW pin. Bootstrap capacitor is charged when low-side power MOSFET is on or SW voltage is	
		low.	
2	VIN	Input supply voltage. Connect a local bypass capacitor from VIN pin to GND pin. Path from VIN	
	VIIV	pin to high frequency bypass capacitor and GND must be as short as possible.	
		Enable pin to the regulator with internal pull-up current source. Pull below 1.1V to	
3	EN	disable the converter. Float or connect to VIN to enable the converter. The tap of resistor divider	
		from VIN to GND connecting EN pin can adjust the input voltage lockout threshold.	
		Set the 20internal oscillator clock frequency or synchronize to an external clock.	
	RT/CLK	Connect a resistor from this pin to ground to set switching frequency. An external clock can be input	
4		directly to the RT/CLK pin. The internal oscillator synchronizes to the external clock frequency with	
		PLL. If detected clocking edges stops, the operation mode automatically returns to resistor	
		programmed frequency.	
		Inverting input of the trans-conductance error amplifier. The tap of external feedback resistor divider	
5	FB	from the output to GND sets the output voltage. The device regulates	
		FB voltage to the internal reference value of 0.8V typical.	
6	COMP	Error amplifier output. Connect to frequency loop compensation network.	
7	GND	Ground.	
8	SW	Regulator switching output. Connect SW to an external power inductor.	
9	Thermal Pad	Heat dissipation path of die. Electrically connection to GND pin. Must be connected to ground plane	
7	Thermai i au	on PCB for proper operation and optimized thermal performance.	

TYPICAL APPLICATION

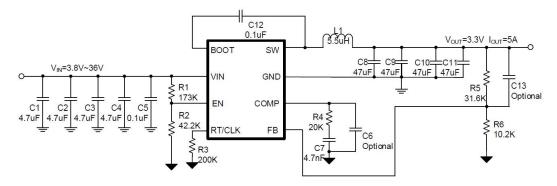


Figure 15. TPS54540D Design Example: 3.3V/3.5A Output, Switching frequency 500KHz

Output Voltage:

$$V_{OUT} = 0.8 \bullet \frac{R_5 + R_6}{R_6}$$

Switching Frequency:

$$f_{SW}(kHz) = \frac{100000}{R_3(k \Omega)}$$



Under Voltage Lock-Out:

$$\begin{split} V_{rise} &= 1.18 \times \left(1 + \frac{R_1}{R_2}\right) - 1.5uA \times R_1 \\ V_{fall} &= 1.10 \times \left(1 + \frac{R_1}{R_2}\right) - 5.5uA \times R_1 \end{split}$$

Compensation Values for Typical Output Voltage/Capacitor Combinations at fsw=500KHz:

Vout	L1	COUT	R4	C7	C6
1.8V	3.3uH	4*47uF	12.1K	6.8nF	100pF(optional)
2.5V	4.7uH	4*47uF	16.9K	4.7nF	68pF (optional)
3.3V	5.5uH	4*47uF	20K	4.7 nF	47pF (optional)
5V	7.8uH	4*47uF	34K	3.3nF	22pF (optional)
12V	10uH	4*47uF	54.9K	1nF	220pF

Inverting Power application

The TPS54540D can be used to convert a positive input voltage to a negative output voltage. Typical applications are amplifiers requiring a negative power supply.

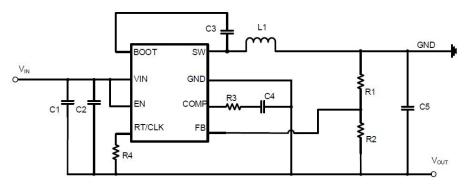
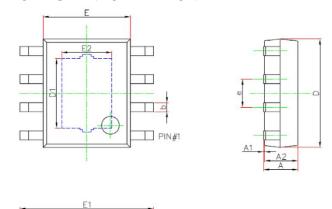


Figure 16.TPS54540D Inverting Power Supply

PACKAGE INFORMATION



Symbol	Dimensions	Dimensions in Millimeters		
Syllibol	Min.	Max.		
Α	1.300	1.700		
A1	0.000	0.100		
A2	1.350	1.550		
b	0.330	0.510		
С	0.170	0.250		
D	4.700	5.100		
D1	3.050	3.250		
E	3.800	4.000		
E1	5.800	6.200		
E2	2.160	2.360		
е	1.270(BSC)			
L	0.400	1.270		
θ	0°	8°		

Figure 17. Package Outline Dimensions Of TPS54540D